

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1		
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	98		2		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	0		3		
		70	L2			
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		4	A01	
		70	L3			
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B(...)	50203001	183		5		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B(...)	50203001	0		6		
		70	L4			
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		7	A02	B00
		70	L5			
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B(...)	50203001	183		8		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B(...)	50203001	0		9		
		70	L6			
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		10	A03	
		70	L7			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B(...)	50203000	98		11		
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...)	50202996	0		12		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	13		

Thickness after Pressing

B00:

1440 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1595 µm

Dmin:

1285 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1550 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1705 µm

Dmin:

1395 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1508 µm

Version 1.2.20.35

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